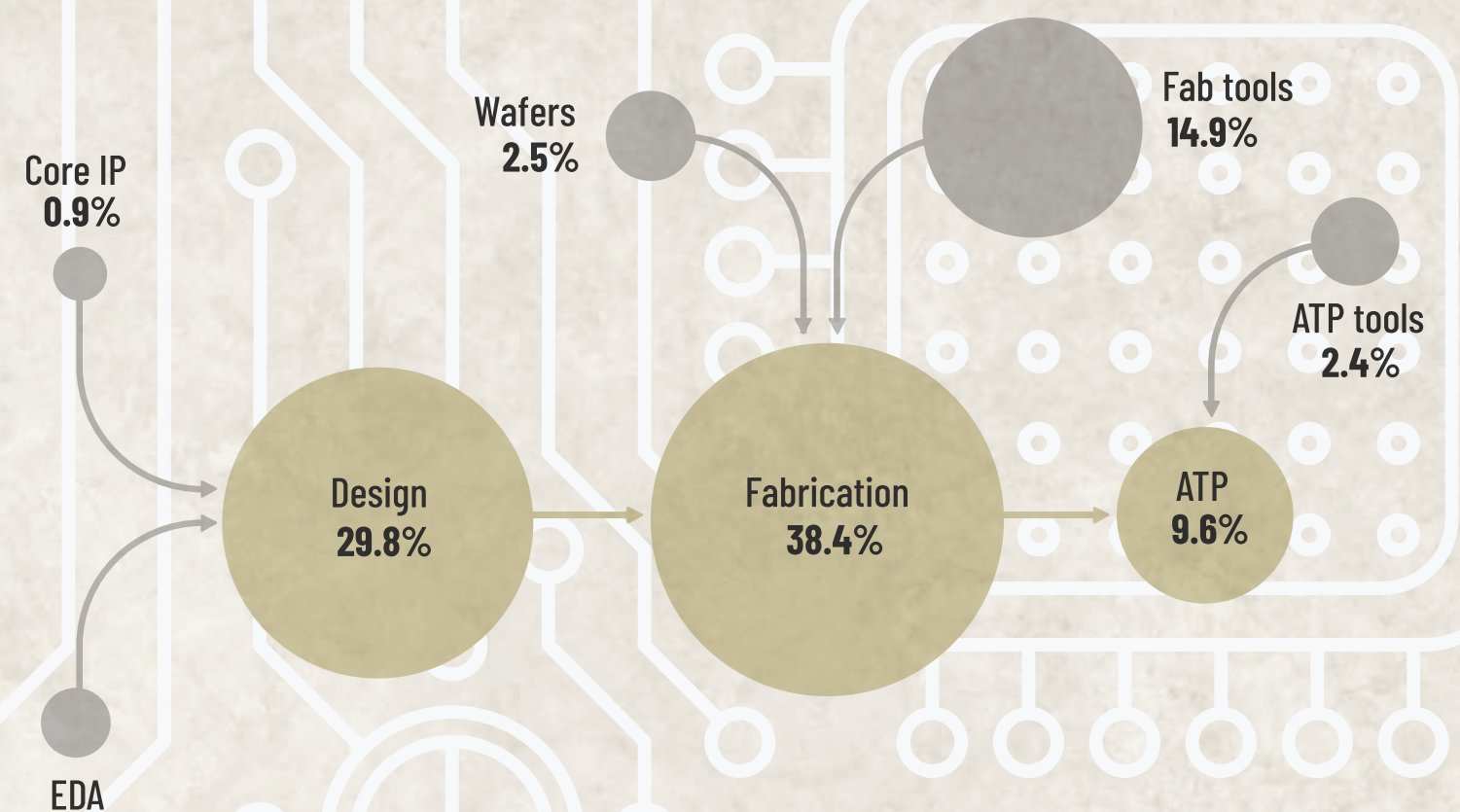


FOLLOW THE MONEY

Design and Fabrication companies take home the lion's share of the value created through the semiconductor supply chain. The percentages below represent the share of the total semiconductor value-add captured by companies at each stage.

semiconductor value-add captured by companies at each stage



Polysilicon		Wafers	
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Wafers

Wafer companies manufacture polysilicon ingots (or provide the equipment to do so), which they then slice and polish to produce the millimeter thin silicon disks, or wafers, onto which hundreds of chips will be etched during the fabrication process.

INDUSTRY LEADERS

 Accretech	 Axcelis	 Ferrotec	 Meyer Burger	 Okamoto	 Shin-Etsu	 SK Siltron	 Soitec	 Toyo Tanso
 Applied Materials	 Disco	 GlobalWafers	 Nissin Ion	 PVA TePla	 Silternic	 SMIT	 SUMCO	 Wafer Works

Firms that do not currently hold a substantial market share but are developing advanced capabilities and could help solidify China's place in the supply chain.

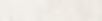
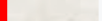
 Click any underlined company to view the company profile in WireScreen

ASSEMBLY, TESTING & PACKAGING

Assembly, Testing and Packaging (ATP) companies prepare chips to be directly usable by smartphone, automotive, and other electronics manufacturers.

INDUSTRY LEADERS

 Amkor	 JCET	 Tongfu Microelectronics
 ASE	 King Yuan (KYEC)	 TSMC
 Chipbond	 Micron	 Unisem Berhad
 ChipMOS	 Powertech	 UTAC
 Hana Micron	 Samsung	
 Hua Tian	 Sigurd	
 Intel	 SK Hynix	

 Hefei Municipal SAMC Chinese municipal government entity Beneficially owns 39.74%	 Powerchip Technology Taiwanese memory and IC chip manufacturer Beneficially owns 20.58%	 Midea Group Chinese household electronics conglomerate Beneficially owns 4.39%	 Anhui Provincial Government SASAC Chinese provincial government entity Beneficially owns 1.64%	 Other Institutional and Individual Investors Beneficially owns 33.65%
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Packaging Tools Materials

Companies that provide the equipment needed to bond assembled chips to protective encasings that can be directly used to power other electronic products.

INDUSTRY LEADERS

	Air Liquide
	Air Products
	Anji
	Avantor
	BASF
	CHC
	DuPont
	Entegris
	Fujifilm Electronic Materials
	Fujimi
	Hitachi
	Honeywell
	Huatae Gas
	Hubei Dinglong
	JHM
	Jinhong Gas
	JSR
	Kanto Chemical
	KMG Chemicals
	LG Chem
	Linde
	Merck Group
	Mitsui Chemicals
	Nata Opto-electronic Material
	PERIC
	Puricon
	Resonac
	Runma
	Saint-Gobain
	Sinophorus
	Sinyang
	SK Materials
	Taiwan Spec. Chem.
	Taiyo Nippon Sanso
	Thomas West
	Versum Materials
	Wonik

Integrated device manufacturers (IDMs) like Intel, Samsung, or Nvidia—who design, manufacture, and sell their own chips in-house—were not represented separately. Instead, they were included in segments in which they can be considered industry leaders.

Companies are listed in alphabetical order and organized by country based on where they are headquartered.

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Sources: Company lists are based on WireScreen research and data with additional advanced logic chip data from the Emerging Technology Observatory's Supply Chain Explorer. Chinese shares of mineral production are based on the 2023 Mineral Commodity Summaries from the United States Geological Survey (USGS). Chinese production of Germanium is from the Critical Raw Materials Alliance. Nexchip ownership data is from WireScreen. Market share and value-added data is from Khan, Mann, and Peterson, "The Semiconductor Supply Chain: Assessing National Competitiveness", CSET, January 2021. Market share and value-added data is from 2019. See source for details.

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